

June 1999 Revised December 2000

GTLP6C817 Low Drive GTLP/LVTTL 1:6 Clock Driver

General Description

The GTLP6C817 is a low drive clock driver that provides TTL to GTLP signal level translation (and vice versa). The device provides a high speed interface between cards operating at TTL logic levels and a backplane operating at GTLP logic levels. High speed backplane operation is a direct result of GTLP's reduced output swing (<1V), reduced input threshold levels and output edge rate control. The edge rate control minimizes bus settling time. GTLP is a Fairchild Semiconductor derivative of the Gunning Transceiver logic (GTL) JEDEC standard JESD8-3

Fairchild's GTLP has internal edge-rate control and is process, voltage, and temperature (PVT) compensated. Its function is similar to BTL and GTL but with different output levels and receiver threshold. GTLP output LOW level is typically less than 0.5V, the output level HIGH is 1.5V and the receiver threshold is 1.0V.

Features

- Interface between LVTTL and GTLP logic levels
- Designed with edge rate control circuitry to reduce output noise on the GTLP port
- V_{REF} pin provides external supply reference voltage for receiver threshold adjustibility
- Special PVT compensation circuitry to provide consistent performance over variations of process, supply voltage and temperature
- TTL compatible driver and control inputs
- Designed using Fairchild advanced CMOS technology
- Bushold data inputs on A port to eliminate the need for external pull-up resistors for unused inputs
- Power up/down and power off high impedance for live insertion
- 5V over voltage tolerance on LVTTL ports
- Open drain on GTLP to support wired-or connection
- A Port source/sink -12mA/+12mA
- B Port sink +40mA
- 1:6 fanout clock driver for TTL port
- 1:2 fanout clock driver for GTLP port

Ordering Code:

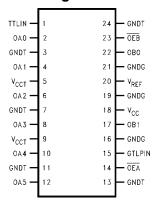
Order Number	Package Number	Package Description
GTLP6C817MTC	MTC24	24-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Device is also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Pin Descriptions

Pin Names	Description	
TTLIN, GTLPIN	Clock Inputs (TTL and GTLP respectively)	
OEB	Output Enable (Active LOW) GTLP Port (TTL Levels)	
OEA	Output Enable (Active LOW) TTL Port (TTL Levels)	
V _{CCT} .GNDT	LVTTL Output Supplies (3V)	
V _{CC}	Internal Circuitry V _{CC} (5V)	
GNDG	OBn GTLP Output Grounds	
V_{REF}	Voltage Reference Input	
OA0-OA5	TTL Buffered Clock Outputs	
OB0-OB1	GTLP Buffered Clock Outputs	

Connection Diagram



Functional Description

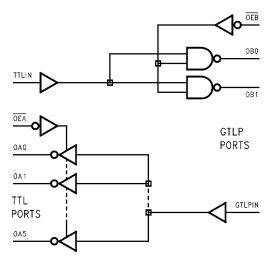
The GTLP6C817 is a low drive clock driver providing LVTTL-to-GTLP clock translation, and GTLP-to-LVTTL clock translation in the same package. The LVTTL-to-GTLP direction is a 1:2 clock driver path with a single Enable pin (OEB). For the GTLP-to-LVTTL direction the clock receiver path is a 1:6 buffer with a single Enable control (OEA). Data polarity is inverting for both directions.

Truth Tables

Inpu	ts	Outputs		
TTLIN	OEB	OBn		
Н	L	L		
L	L	Н		
X	Н	High Z		

Inpu	ts	Outputs
GTLPIN	OEA	OAn
Н	L	L
L	L	Н
Х	Н	High Z

Logic Diagram



Absolute Maximum Ratings(Note 1) Recomm

 $\label{eq:supply Voltage VCC} Supply Voltage (V_{CC}) & -0.5V to +7.0V \\ DC Input Voltage (V_I) & -0.5V to +7.0V \\ \end{array}$

oc input voitage (vi)

DC Output Voltage (V_O)

DC Output Sink Current into OA Port I_{OL}

DC Output Source Current from OA Port I_{OH}

DC Output Sink Current into OB Port in the LOW State I_{OL}

DC Input Diode Current (I_{IK}) $V_I < 0V$

ESD Rating > 2000 V Storage Temperature (T_{STG}) $-65^{\circ}\text{C to } +150^{\circ}\text{C}$

Recommended Operating Conditions (Note 3)

Supply Voltage

24 mA

-24 mA

80 mA

-50 mA

V_{CC} 4.75V to 5.25V V_{CCT} 3.15V to 3.45V

Bus Termination Voltage (V_{TT})

GTLP 1.47V to 1.53V V_{REF} 0.98V to 1.02V

Input Voltage (V_I) on INA Port

and Control Pins 0.0V to 5.5V

HIGH Level Output Current (I_{OH})

OA Port -12 mA

LOW Level Output Current (I_{OL})

OA Port +12 mA
OB Port +40 mA
Operating Temperature (T_A) -40°C to +85°C

Note 1: Absolute Maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute maximum rated conditions is not implied.

Note 2: I_o Absolute Maximum Rating must be observed.

Note 3: Unused input must be held HIGH or LOW.

DC Electrical Characteristics

Over Recommended Operating Free-Air Temperature Range, $V_{REF} = 1.0V$ (unless otherwise noted).

Symbol		Test Conditions		Min	Typ (Note 4)	Max	Units
V _{IH}	GTLPIN			V _{REF} + 0.05		V _{TT}	V
	Others			2.0			V
V _{IL}	GTLPIN			0.0		V _{REF} - 0.05	V
	Others					0.8	V
V _{REF}	GTLP				1.0		V
(Note 5)	GTL				0.8		V
V _{TT}	GTLP				1.5		V
(Note 5)	GTL				1.2		V
V _{IK}		V _{CC} = 4.75V	I _I = -18 mA			-1.2	V
		$V_{CCT} = 3.15V$	II = -10 IIIA			-1.2	V
V _{OH}	OAn Port	V _{CC} = 4.75V	$I_{OH} = -100 \mu A$	V _{CC} - 0.2			
		$V_{CCT} = 3.15V$	$I_{OH} = -6 \text{ mA}$	2.4			V
			$I_{OH} = -12 \text{ mA}$	2.2			
V _{OL}	OAn Port	V _{CC} = 4.75V	$I_{OL} = 100 \mu A$			0.2	
		$V_{CCT} = 3.15V$	$I_{OL} = 6 \text{ mA}$			0.4	V
			$I_{OL} = 12 \text{ mA}$			0.5	
V _{OL}	OBn Port	V _{CC} = 4.75V	$I_{OL} = 100 \mu A$			0.2	V
		$V_{CCT} = 3.15V$	$I_{OL} = 40 \text{ mA}$			0.5	V
II	TTLIN/	V _{CC} = 5.25V	$V_{I} = 5.25V$			5	μА
	Control Pins	$V_{CCT} = 3.45V$	$V_I = 0V$			-5	μА
	GTLPIN	V _{CC} = 5.25V	$V_I = V_{TT}$			5	μА
		$V_{CCT} = 3.45V$	$V_I = 0$			-5	μΛ
I _{OFF}	TTLIN, OAn Port, Control Pins	V _{CC} = 0	V_I or $V_O = 0V$ to 5.25V			30	
	GTLPIN, OBn Port	$V_{CCT} = 0$	V_I or $V_O = 0$ to V_{TT}			30	μΑ
l _{OZH}	OAn Port	V _{CC} = 5.25V	V _O = 5.25V			5	
	OBn Port	$V_{CCT} = 3.45V$	V _O = 1.5V			5	μА
I _{OZL}	OAn Port	V _{CC} = 5.25V	V _O = 0			-5	
	OBn Port	V _{CCT} = 3.45V	$V_{O} = 0$			_s	μΑ

DC Electrical Characteristics (Continued)

Symbol		Test Conditions		Min	Typ (Note 4)	Max	Units	
I _{PU/PD}	All Ports	$V_{CC} = V_{CCT} = 0 \text{ to } 1.5V$	OE = Don't Care			30	μА	
I _{CC} (5V)	OAn or	V _{CC} = 5.25V	Outputs HIGH			10		
	OBn Ports	$V_{CCT} = 3.45V$	Outputs LOW			10	mA	
			Outputs Disabled			10	IIIA	
			$V_I = V_{CC}$ or GND					
I _{CC} (3V)	OAn or	V _{CC} = 5.25V	Outputs HIGH, LOW			45		
	OBn Ports	$V_{CCT} = 3.45V$	Outputs Disabled			45	μΑ	
			$V_I = V_{CC}$ or GND					
Δl _{CC}	TTLIN	$V_{CC} = 5.25V$ $V_{CCT} = 3.45V$	V _I = V _{CC} -2.1			1	mA	
C _{IN}	Control Pins/GTLPIN/TTLIN		$V_I = V_{CC}$ or 0		3	3.5	pF	
C _{OUT}	OAn Port		$V_I = V_{CC}$ or 0		3	4.5	pF	
	OBn Port		$V_I = V_{CC}$ or 0		4	5	PΓ	

Note 4: All typical values are at V_{CC} = 5.0V V_{CCT} = 3.3V and T_A = 25°C.

Note 5: GTLP V_{REF} and V_{TT} are specified to 2% tolerance since signal integrity and noise margin can be significantly degraded if these supplies are noisy. In addition, V_{TT} and R_{TERM} can be adjusted to accommodate backplane impedances other than 50Ω , within the boundaries of not exceeding the DC Absolute I_{OL} ratings. Similarly V_{REF} can be adjusted to compensate for changes in V_{TT} .

AC Electrical Characteristics

Over recommended range of supply voltage and operating free air temperature. $V_{REF} = 1.0V$ (unless otherwise noted).

 $C_L = 30 \text{ pF}$ for OBn Port and $C_L = 50 \text{ pF}$ for OAn Port.

Cumhal	From	То	Min	Тур	Max	Units
Symbol	(Input)	(Output)		(Note 6)		Units
t _{PLH}	TTLIN	OBn	2.3		4.7	ns
t _{PHL}			1.5		4.6	115
t _{PLH}	OEB	OBn	2.4		4.8	
t _{PHL}			1.6		4.7	ns
t _{RISE} Transition Time, OB Outputs (20% to		Outputs (20% to 80%)		1.7		ns
t _{FALL} Transition Time, OB outputs (2		outputs (20% to 80%)		2.1		ns
t _{RISE}	Transition Time, OA outputs (10% to 90%)			2.7		ns
t _{FALL}	Transition Time, OA	outputs (10% to 90%)		2.2		ns
t _{PZH} , t _{PZL}	OEA	OAn	2.4		6.5	20
t _{PLZ} , t _{PHZ}			2.0		6.5	ns
t _{PLH}	GTLPIN	OAn	3.1		6.6	ns
t _{PHL}			2.8		6.0	115

Note 6: All typical values are at $V_{CC} = 5.0 \text{V}$ and $T_A = 25^{\circ}\text{C}$.

Extended Electrical Characteristics

Over recommended ranges of supply voltage and operating free-air temperature $V_{REF} = 1.0V$ (unless otherwise noted).

 $C_L = 30$ pF for B Port and $C_L = 50$ pF for A Port.

Symbol		From (Input)	To (Output)	Min	Typ (Note 7)	Max	Unit
t _{OSLH}	(Note 8)	Α	В		.05	.4	
toshl	(Note 8)	Α	В		.05	.4	ns
t _{PS}	(Note 9)	A	В		0.5	1.0	ns
t _{PV(HL)}	(Note 10) (Note 11)	А	В			.7	ns
toslh	(Note 8)	В	Α		.12	.5	ns
toshl	(Note 8)	В	A		.12	.5	113
t _{OST}	(Note 8)	В	A		.6	1.0	ns
t _{PS}	(Note 9)	В	A		0.5	1.0	ns
t _{PV}	(Note 10)	В	A			1.2	ns

Note 7: All typical values are at $V_{CC} = 5.0 V$ and $T_A = 25 ^{\circ} C$.

Note 8: t_{OSHL}/t_{OSLH} and t_{OST} - Output-to-Output skew is defined as the absolute value of the difference between the actual propagation delay for all outputs within the same packaged device. The specifications are given for specific worst case V_{CC} and temperature and apply to any outputs switching in the same direction either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}) or in opposite directions both HL and LH (t_{OST}). This parameter is guaranteed by design and statistical process distribution. Actual skew values between the GTLP outputs could vary on the backplane due to the loading and impedance seen by the device

Note 9: t_{PS} - Pin or Transition skew is defined as the difference between the LOW-to-HIGH transition and the HIGH-to-LOW transition on the same pin. The parameter is measured across all the outputs of the same chip is specified for a specific worst case V_{CC} and temperature. This parameter is guaranteed by design and statistical process distribution. Actual skew values between the GTLP outputs could vary on the backplane due to the loading and impedance seen by the device.

Note 10: t_{PV} - Part-to-Part skew is defined as the absolute value of the difference between the actual propagation design for all outputs from device-to-device. The parameter is specified for a specific worst case V_{CC} and temperature. This parameter is guaranteed by design and statistical process distribution. Actual skew values between the GTLP output could vary on the backplane due to the loading and impedance seen by the device.

Note 11: Due to the open drain structure on GTLP outputs, t_{OST} and $t_{PV(LH)}$ in the A-to-B direction are not specified. Skew on these paths is dependent on the V_{TT} and R_T values in the actual application.

Test Circuit and Timing Waveforms

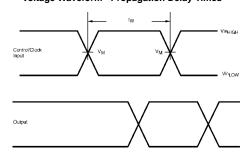
From Output $C_L = 50 \, pF$ S_{PLH}/t_{PHL} Open t_{PLZ}/t_{PZH} t_{PHZ}/t_{PZH} t_{PNL} t_{PNL}

Note A: C_L includes probes and jig capacitance.

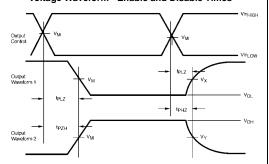
Test Circuit for B Outputs 1.5V (GTLP) 1.2V (GTL) From Output Under Test 30 pF (Notes A, B)

Note A: C_L includes probes and jig capacitance. Note B: For B Port $C_L=30\ pF$ is used for worst case.

Voltage Waveform - Propagation Delay Times



Voltage Waveform - Enable and Disable Times

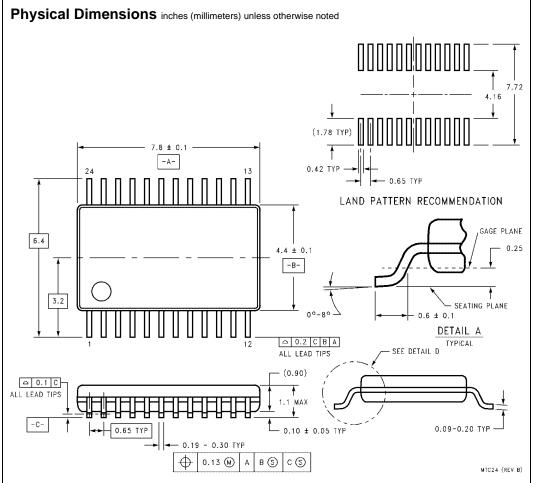


Output Waveform 1 is for an output with internal conditions such that the output is LOW except when disabled by the control output Output Waveforms 2 is for an output with internal conditions such that the output is HIGH except when disabled by the control output

Input and Measure Conditions

	A or LVTTL Pins	B or GTLP Pins
V_{inHIGH}	V _{CC}	1.5
V_{inLOW}	0.0	0.0
V _M	V _{CC} /2	1.0
V _X	$V_{OL} + 0.3V$	N/A
V _Y	V _{OH} + 0.3V	N/A

All input pulses have the following characteristics: Frequency = 10MHz, $t_{RISE} = t_{FALL} = 2$ ns, $Z_O = 50\Omega$. The outputs are measured one at a time with one transition per measurement.



24-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC24

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